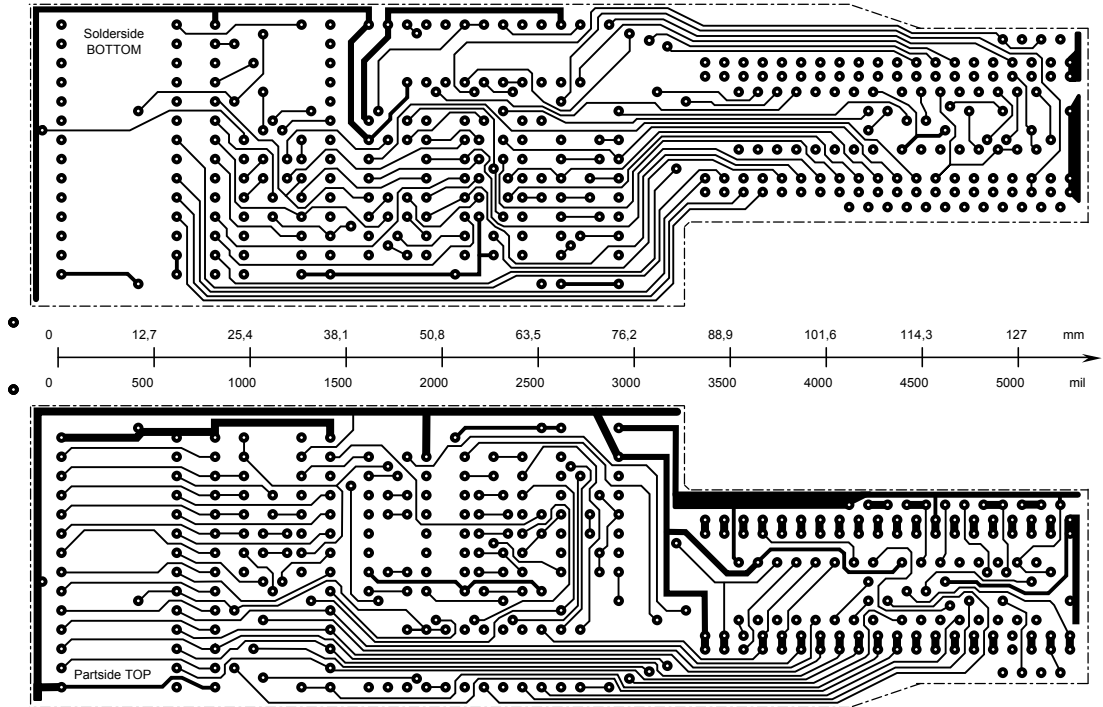
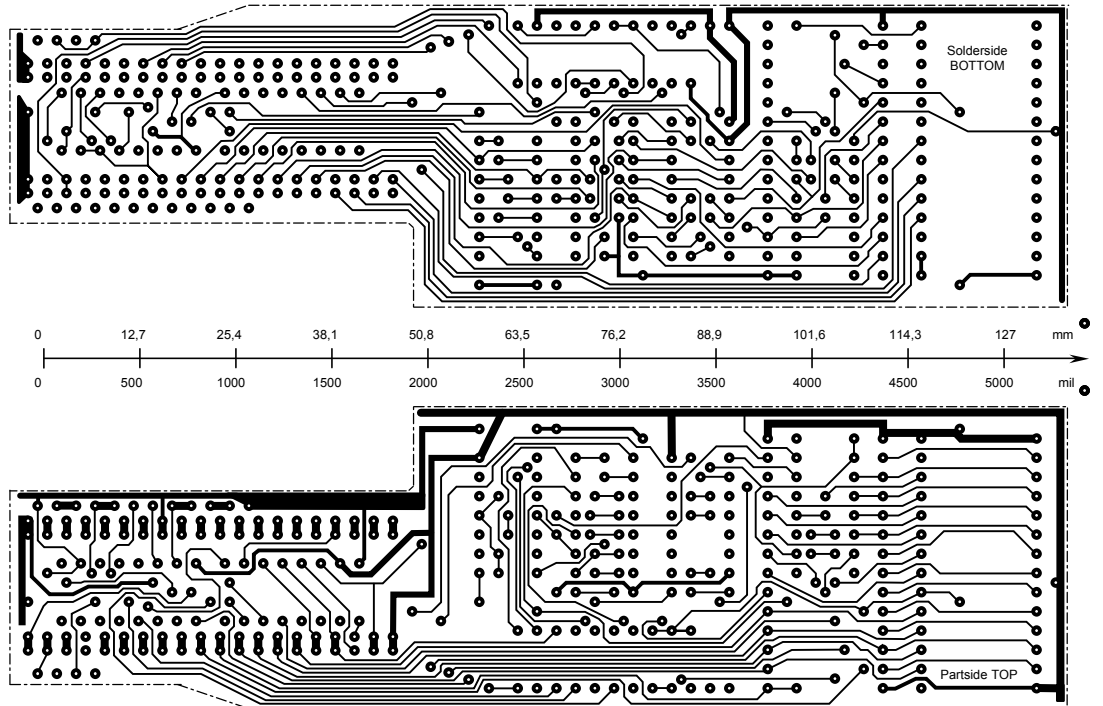


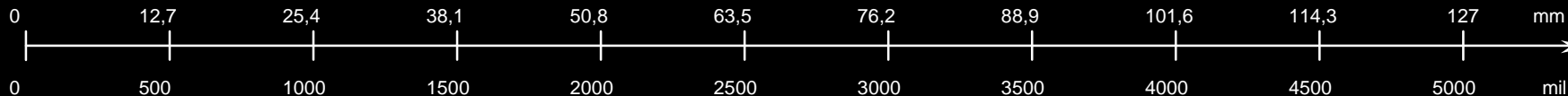
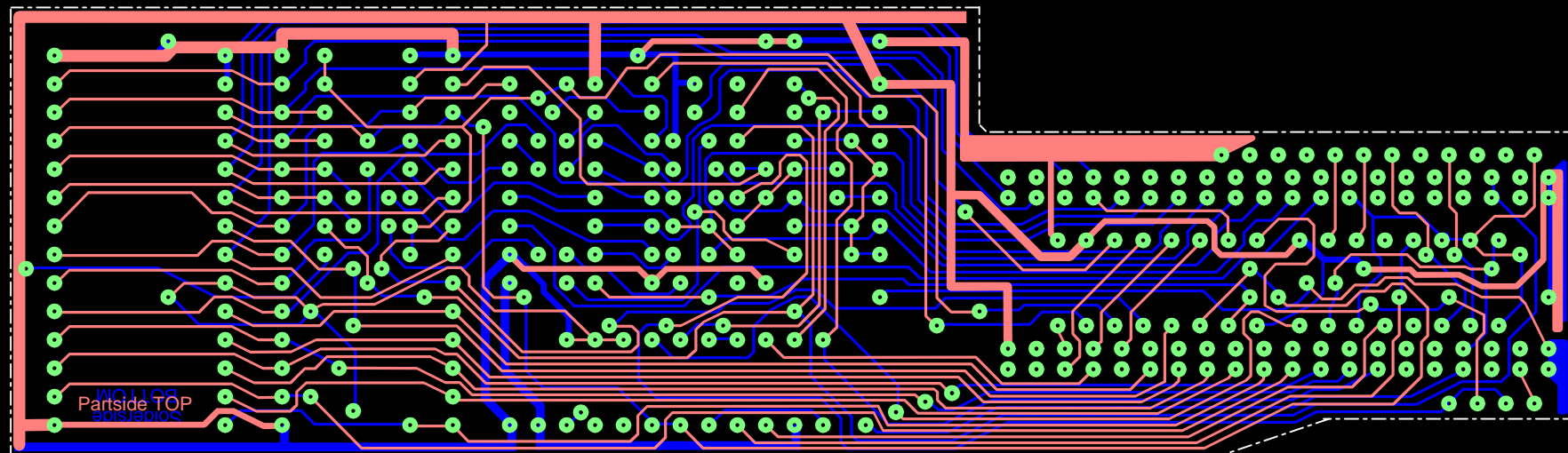
Reconstructed PCB (top and bottom layer) of Professional-DOS



Reconstructed PCB (top and bottom layer) of Professional-DOS;  
mirrored for photo reproduction (already scaled correctly to 100%)

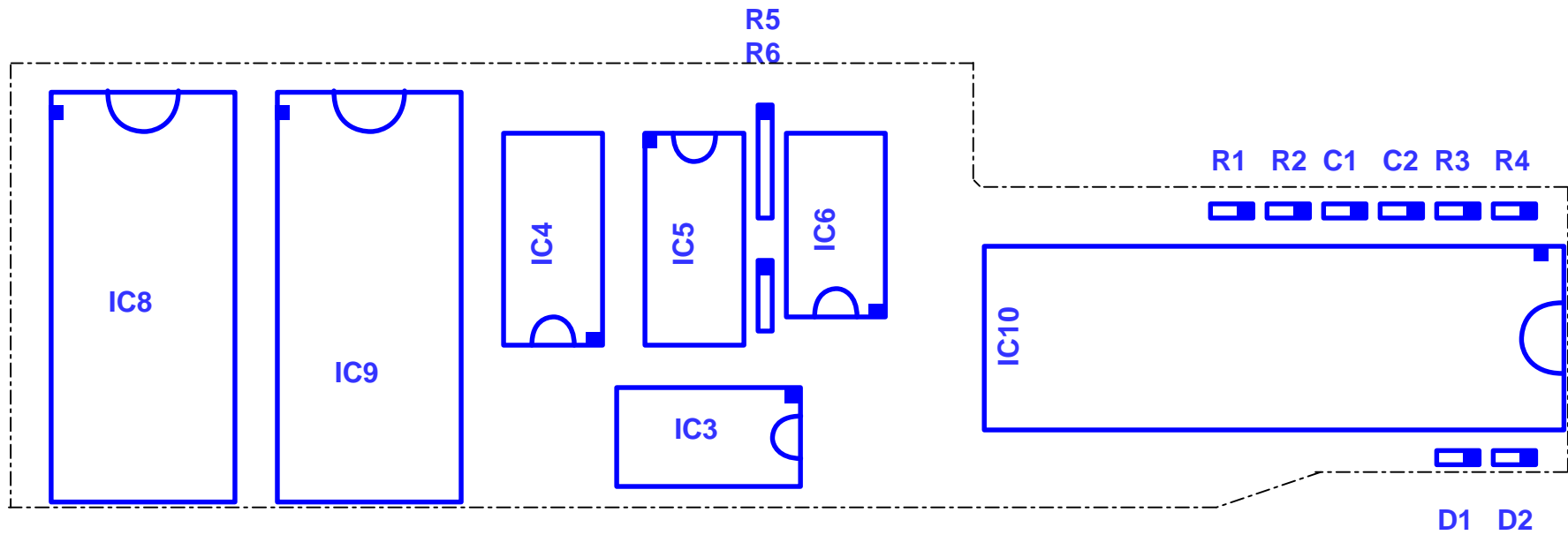
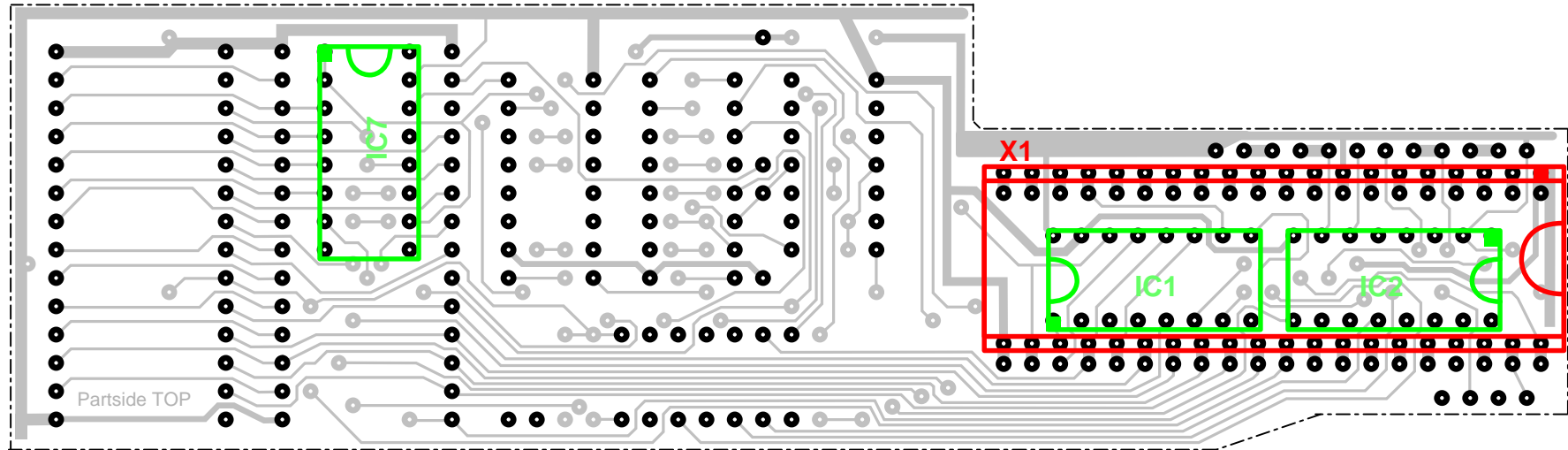


Two-layer view of the reconstructed PCB

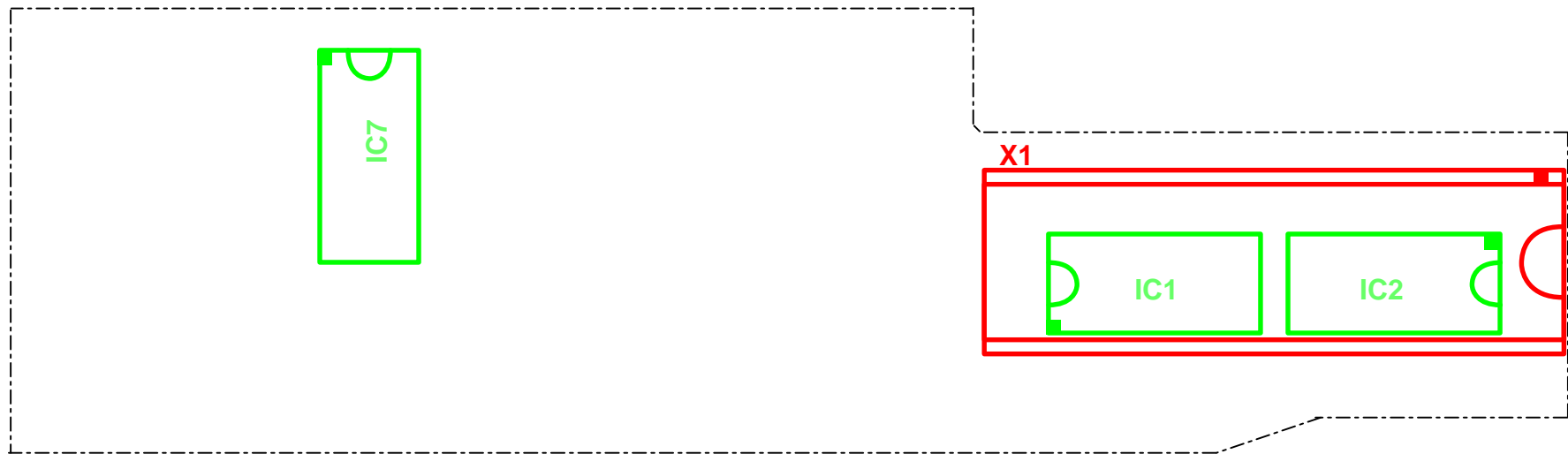
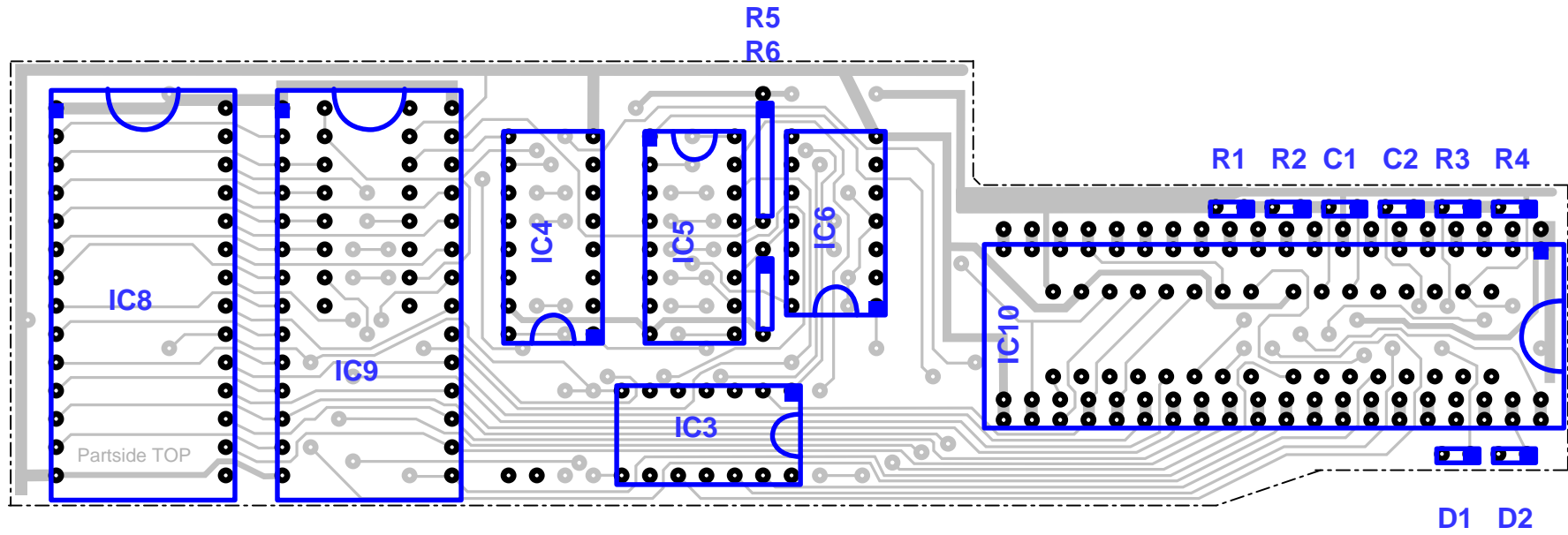


Partside TOP

PCB-Layout with the IC adaptor mounted onto the bottom side and parts mounted between sockets (first installation step)



PCB-Layout with directly mounted parts (second installation step)



# Legend:

<b>R1, R4:</b>	Resistor, 1K5 $\pm$ 1%
<b>R2, R3:</b>	Resistor, 9K1 $\pm$ 1%
<b>R5, R6:</b>	Resistor, 1K8 $\pm$ 1%
<b>C1, C2:</b>	Capacitor, 56 pF
<b>D1, D2:</b>	Diode, 1N4148
<b>IC3:</b>	74LS00, directly mounted onto the PCB
<b>IC4:</b>	74LS157, directly mounted onto the PCB
<b>IC5:</b>	74LS367, directly mounted onto the PCB
<b>IC6:</b>	74LS74, directly mounted onto the PCB
<b>IC8:</b>	EPROM, 27128, placed into a socket
<b>IC9:</b>	Static RAM CMOS 8192x8, TC5565PL-15 or similar (6164, 6264LP-10, ...), placed into a socket
<b>IC10:</b>	empty socket, 40 pin (reserved for 6502 processor)
<b>IC1:</b>	82S123 (aka. 74S188), mounted below IC10
<b>IC2:</b>	74LS123
<b>IC7:</b>	74LS173, mounted below IC9 which has to be placed into a socket
<b>X1:</b>	IC adaptor, 40 pin, soldered onto the bottom side of the PCB

Pin 1 of all components is marked with a little square (■). In case of the diodes, pin 1 marks the cathode. In case of the resistors and capacitors, pin 1 is only marked for a description of the connection scheme.